## **CERAMIC SMD CRYSTAL**





ABM3C

**RoHS/RoHS II Compliant** 

5.0 x 3.2 x 1.3mm

ABM3C Series products with the Date Code/Traceability Code marking ending in "X" are Glass-Sealed and the following RoHS Exemption applies: Pb in Glass, exemption 7C-I per RoHS II Directive 2011/65/EU Annex

ABM3C Series products with the Date Code/Traceability Code marking ending in "C" and "F" are Seam-Sealed and are Pb-Free.

Moisture Sensitivity Level – MSL – N/A (The ABM3C Series is a Hermetically Sealed device and not moisture sensitive)

### **FEATURES:**

- Low height; suitable for thin equipment.
- New seam sealed package available (code "C")
- Tight tolerance and stability available.
- Suitable for RoHS compliant reflow profile

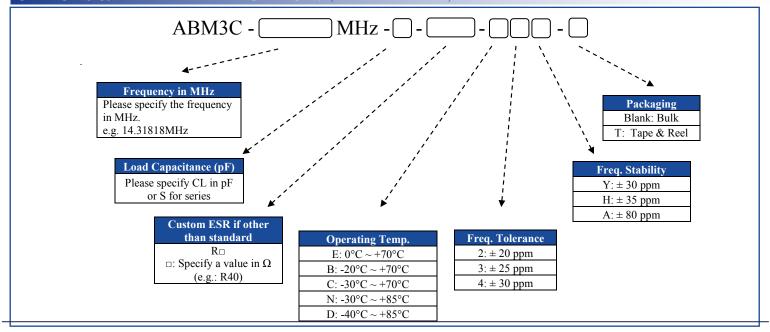
### **APPLICATIONS:**

- High density applications.
- Modems, communication and test equipment.
- PMCIA, Wireless applications

## STANDARD SPECIFICATIONS:

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency Range	10.000		50.000	MHz	Fundamental
Operation Mode	Fundamental				
Operating Temperature	-10		+70	°C	See options
Storage Temperature	-40		+90	°C	
Frequency Tolerance @+25°C	-50		+50	ppm	See options
Frequency Stability over the Operating Temperature ( ref. to +25°C)	-50		+50	ppm	See options
Equivalent series resistance (R1)			60	Ω	10.000 – 15.999MHz
			50	32	16.000 – 50.000MHz
Shunt capacitance (C0)			7	pF	
Load capacitance (CL)		18		pF	Standard (See options if other than STD)
Drive Level		10	100	$\mu W$	
Aging	-5		+5	ppm	@25°C±3°C First year
Insulation Resistance	500			MΩ	$ @ 100 \text{Vdc} \pm 15 \text{V} $

## OPTIONS & PART IDENTIFICATION: (Left blank if standard)





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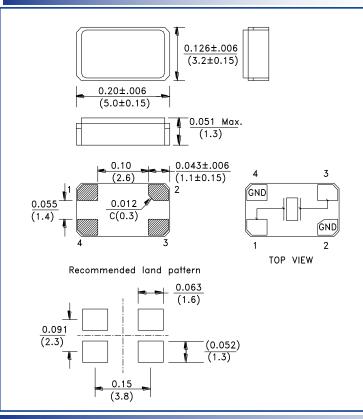
**RoHS/RoHS II Compliant** 





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## **OUTLINE DRAWING:**



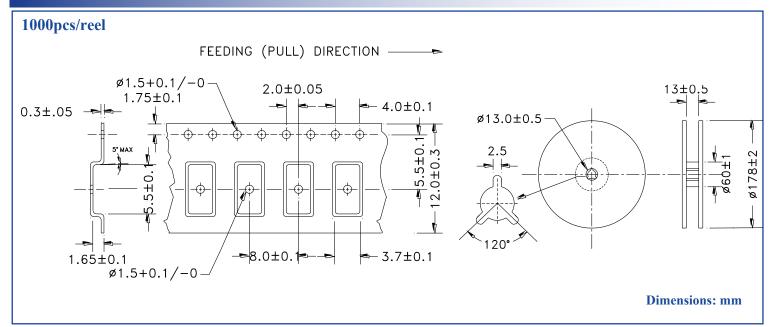
#### **Sealing Method:**

Glass Sealing for parts with Traceability Code ending in "X" Seam Sealing for parts with Traceability Code ending in "C" and "F"

Note: Due to material availability, the chamfer could be located on pin #1 or #2. Be advised that the chamfer location has no impact on the electrical performance of the device.

**Dimensions: inches (mm)** 

## **TAPE & REEL:**



**REVISED: 09-07-21** 

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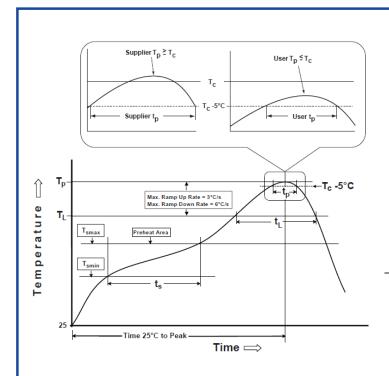
**RoHS/RoHS II Compliant** 





5.0 x 3.2 x 1.3mm

## **REFLOW PROFILE:**



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Table 2

**Pb-Free Process** Classification Temperatures (Tc) Volume mm<sup>3</sup> Package Volume mm<sup>3</sup> Volume mm<sup>3</sup> Thickness <350 350-2000 >2000 260 °C 260 °C 260 °C <1.6 mm 245 °C 1.6 mm - 2.5 mm 260°C 250 °C 250 °C 245 °C 245 °C >2.5 mm

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T <sub>smin</sub> )	100°C	150°C
Temperature maximum (T <sub>smax</sub> )	150°C	200°C
Time $(T_{smin} \text{ to } T_{smax})$ $(t_s)$	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/sec. max	3°C/sec. max
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T <sub>P</sub> )*	see Table 1	see Table 2
Time (t <sub>p</sub> )** within 5°C of the specified classification temperature (T <sub>C</sub> )	20 sec.	30 sec.
Ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max
Reflow cycles	2 max	2 max

<sup>\*</sup>Tolerance for peak profile temperature (T<sub>P</sub>) is defined as a supplier minimum and a user maximum.

**ATTENTION:** Abracon Corporation's products are COTS – Commercial-Off-The-Shelf products; suitable for Commercial, Industrial and, where designated, Automotive Applications. Abracon's products are not specifically designed for Military, Aviation, Aerospace, Life-dependant Medical applications or any application requiring high reliability where component failure could result in loss of life and/or property. For applications requiring high reliability and/or presenting an extreme operating environment, written consent and authorization from Abracon Corporation is required. Please contact Abracon Corporation for more information.



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<sup>\*\*</sup>Tolerance for time at peak profile temperature  $(t_p)$  is defined as supplier minimum and a user maximum.